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PATENT REEL: 010062 FRAME: 0080

ASSIGNMENT

In consideration of the sum of One United States Dollar (U.S. \$1.00) in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned,

Inventor(s) full name(s)	Paolo LULPANI
	hereby sell, assign and transfer to
Assignee Name and Address	STMicroelectronics s.r.l.
	Via C. Olivetti, 2
	20041 AGRATE BRIANZA (MI) - Italy
	(hereinafter called the Assignee) the entire right, title, and interest in and to any and all improvements which are disclosed in the application for United States Letters Patent entitled
Title of	PROCESS FOR FABRICATING A SEMICONDUCTOR NON-VOLATILE MEMORY DEVICE
Invention	WITH SHALLOW TRENCH ISOLATION (STI)
	which application was
Complete	(a) executed by the undersigned on the 28th day of
(a) or (b)	(b) filed on the day of, 19, Serial No
	benefits under the International Convention for the Protection of Industrial Property. It is hereby authorized and requested that the Commissioner of Patents and Trademarks issue any and all of said Letters Patent, when granted, to said Assignee.
	Further, it is agreed that, when requested, without charge to but at the expense of said Assignee, the undersigned will execute all divisional, continuing, substitute, renewal and reissue patent applications; execute all rightful other papers; and generally do everything possible which said Assignee shall consider desirable for aiding in securing and maintaining proper patent protection.
ocation	Signed at MILANO
ite	this 28th day of May, 1999.
	INVENTOR(S):
ventor(s) 11 gnature(s)	Paolo COLPANI Sale la Poni

RECORDED: 06/18/1999

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